

General Description

The WSF25N20 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSF25N20 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

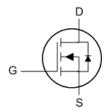
BV _{DSS}	R _{DSON}	I _D
200V	60mΩ	25A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

TO-252 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	200	V
V_{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	25	Α
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	16	Α
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	3.7	Α
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	3.0	Α
I _{DM}	I _{DM} Pulsed Drain Current ²		Α
EAS	Single Pulse Avalanche Energy ³	35	mJ
I _{AS}	I _{AS} Avalanche Current		Α
P _D @T _C =25℃	P _D @T _C =25℃ Total Power Dissipation ³		W
P _D @T _C =100℃	P _D @T _C =100℃ Total Power Dissipation ³		W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J Operating Junction Temperature Range		-55 to 150	$^{\circ}$ C

Thermal Data

Symbol	Parameter		Max.	Unit
R _{0JA}	Thermal Resistance Junction-ambient ¹		50	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		1.1	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	rain-Source Breakdown Voltage V _{GS} =0V , I _D =250uA				V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25 $^{\circ}\mathrm{C}$, I _D =1mA		0.098		V/°C
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =12A		60	75	mΩ
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =6.0V , I _D =10A		85	150	mΩ
V _{GS(th)}	Gate Threshold Voltage)/ -\/ -250\	1.0	1.5	2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-4.57		mV/℃
	Dunin Course Lookens Current	V _{DS} =160V , V _{GS} =0V , T _J =25℃			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =160V , V _{GS} =0V , T _J =55℃			5	uA
I _{GSS}	Gate-Source Leakage Current V _{GS} =±25V , V _{DS} =0V				±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =8A		20		S
Rg	Gate Resistance V _{DS} =0V , V _{GS} =0V , f=1MHz			2	4	Ω
Q_g	Total Gate Charge (10V)			40		
Q_gs	Gate-Source Charge	V _{DS} =100V , V _{GS} =10V , I _D =12A		14		nC
Q _{gd}	Gate-Drain Charge			10		
T _{d(on)}	Turn-On Delay Time			16		
Tr	Rise Time	V_{DD} =30V , V_{GS} =10V , R_{G} =6 Ω ,		7		
T _{d(off)}	Turn-Off Delay Time	I _D =12A, R _L =30Ω		37		ns
T _f	Fall Time			15		
Ciss	Input Capacitance			2350		
C _{oss}	Output Capacitance	V _{DS} =30V , V _{GS} =0V , f=1MHz		155		pF
C _{rss}	Reverse Transfer Capacitance			45		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.5mH , I _{AS} =6.5A	10			mJ

Diode Characteristics

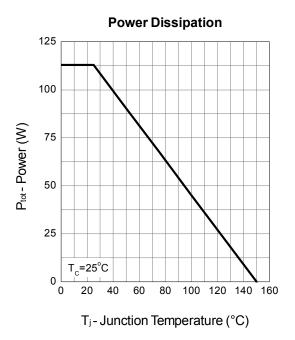
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	V =V =0V Force Current			12	Α
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			36	Α
V _{SD}	Diode Forward Voltage ² V _{GS} =0V , I _S =12A , T _J =25℃				1.3	V
t _{rr}	Reverse Recovery Time			75		nS
Q _{rr}	Reverse Recovery Charge	lF=12A , dl/dt=100A/μs , T _J =25℃		250		nC

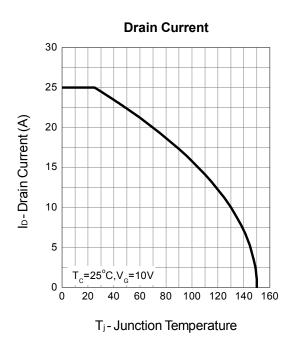
Note:

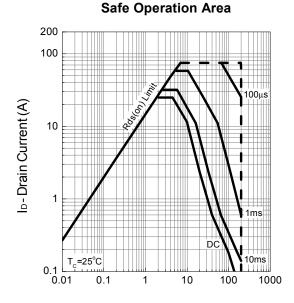
- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<=10sec.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3.The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.5mH,I_{AS}=6.5A
- 5.The Min. value is 100% EAS tested guarantee.
- 6.The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.



Typical Characteristics

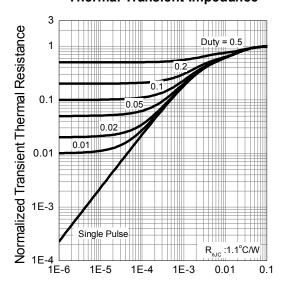






V_{DS} - Drain - Source Voltage (V)

Thermal Transient Impedance

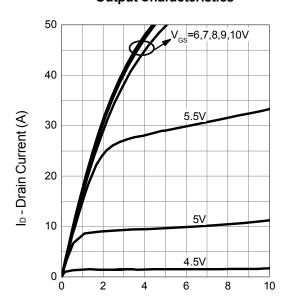


Square Wave Pulse Duration (sec)



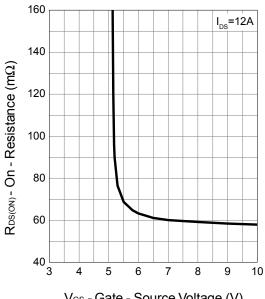
Typical Characteristics

Output Characteristics



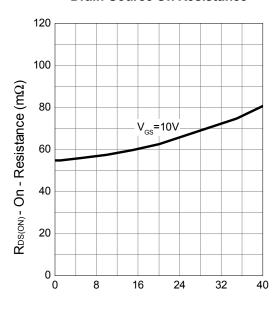
V_{DS}-Drain - Source Voltage (V)

Gate-Source On Resistance



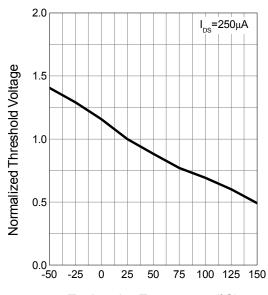
V_{GS} - Gate - Source Voltage (V)

Drain-Source On Resistance



ID-Drain Current (A)

Gate Threshold Voltage

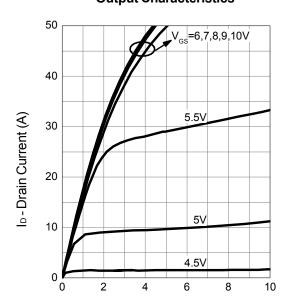


T_j - Junction Temperature (°C)



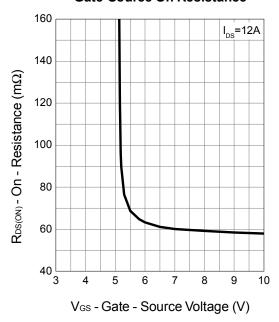
Typical Characteristics

Output Characteristics

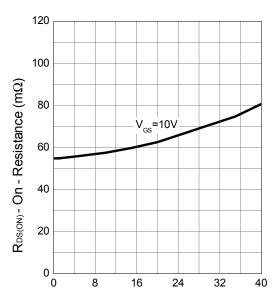


V_{DS} - Drain - Source Voltage (V)

Gate-Source On Resistance

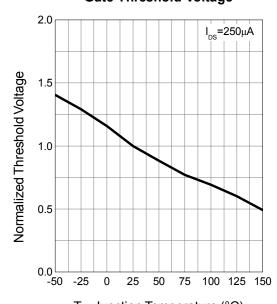


Drain-Source On Resistance



ID-Drain Current (A)

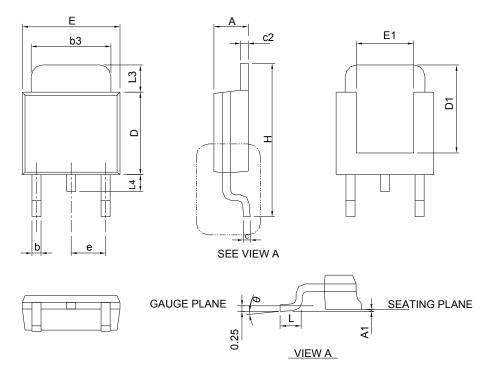
Gate Threshold Voltage



T_j - Junction Temperature (°C)

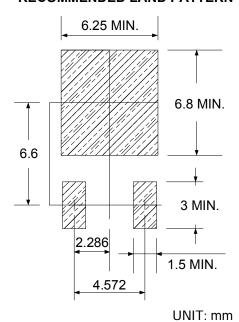


TO-252 Package Information



Ş	TO-252			
SYMBO.	MILLIMETERS		INC	HES
6	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	-	0.13	-	0.005
b	0.50	0.89	0.020	0.035
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c2	0.46	0.89	0.018	0.035
D	5.33	6.22	0.210	0.245
D1	4.57	6.00	0.180	0.236
Е	6.35	6.73	0.250	0.265
E1	3.81	6.00	0.150	0.236
е	2.29 BSC		0.090) BSC
Н	9.40	10.41	0.370	0.410
L	0.90	1.78	0.035	0.070
L3	0.89	2.03	0.035	0.080
L4	-	1.02	-	0.040
θ	0°	8°	0°	8°

RECOMMENDED LAND PATTERN





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